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(71) Applicant : MATSUSHITA ELECTRIC
INDUSTRIAL CO., LTD
1006, Oaza Kadoma,
Kadoma-shi
Osaka 571 (JP)

(72) Inventor : Nakatsuka, Shigeki
36-2, Fukakusa Kaido-cho,
Fushimi-ku
Kyoto-shi, Kyoto, 612 (JP)

Inventor : Ichikawa, Iwao
17-12-119, Mondosou, Nishinomiya-shi,
Hyogo, 662 (JP)

Inventor : Morioka, Manabu
3-5, Mimatsugaoka, Nara-shi,
Nara, 631 (JP)

Inventor : Kato, Kenji
62-1, Kaidashin-machi,
Hirakata-shi, Osaka, 573 (JP)
Inventor : Fujita, Takayuki
6-6, Ikaga Sakae-machi, Hirakata-shi,
Osaka, 573 (JP)

Inventor : Negishi, Shigetoshi
4-41-5-112, Yamadahigashi,
Suita-shi, Osaka, 565 (JP)
Inventor : Shiga, Kazuhiro,
4-1-1-712, Nishimakino,
Hirakata-shi, Osaka, 573 (JP)

(74) Representative : Patentanwälte Grünecker,
Kinkeldey, Stockmair & Partner
Maximilianstrasse 58
D-80538 München (DE)

(54) Exterior view inspecting apparatus for circuit board.

(57) The exterior view inspecting apparatus for circuit board of the invention comprises :

a sensor unit for emitting laser beam to an object to be inspected, and detecting the displacement of the object by focusing the reflected light on an photoelectric transducer by using a receiving lens,

an optical path converter unit for refracting the optical path of radiation laser beam,

a sensor head unit incorporating the sensor unit and optical path converter unit,

a control unit for moving the sensor head unit along a specified scanning route,

a correction unit for correcting the displacement data of the object to be inspected detected by the sensor unit, and

a judging unit for judging the existence and position of an electronic component on a circuit board from the corrected displacement data.

The optical path converter unit comprises a flat sheet glass inclined to the optical path of the radiation laser beam, rotating about the axial center parallel to the optical path.

By this optical path converter unit, the optical path of the radiation laser beam is refracted so that the radiation laser beam scans the circuit board drawing a small circular trace. the trace draws a small circle, the trace detects the end

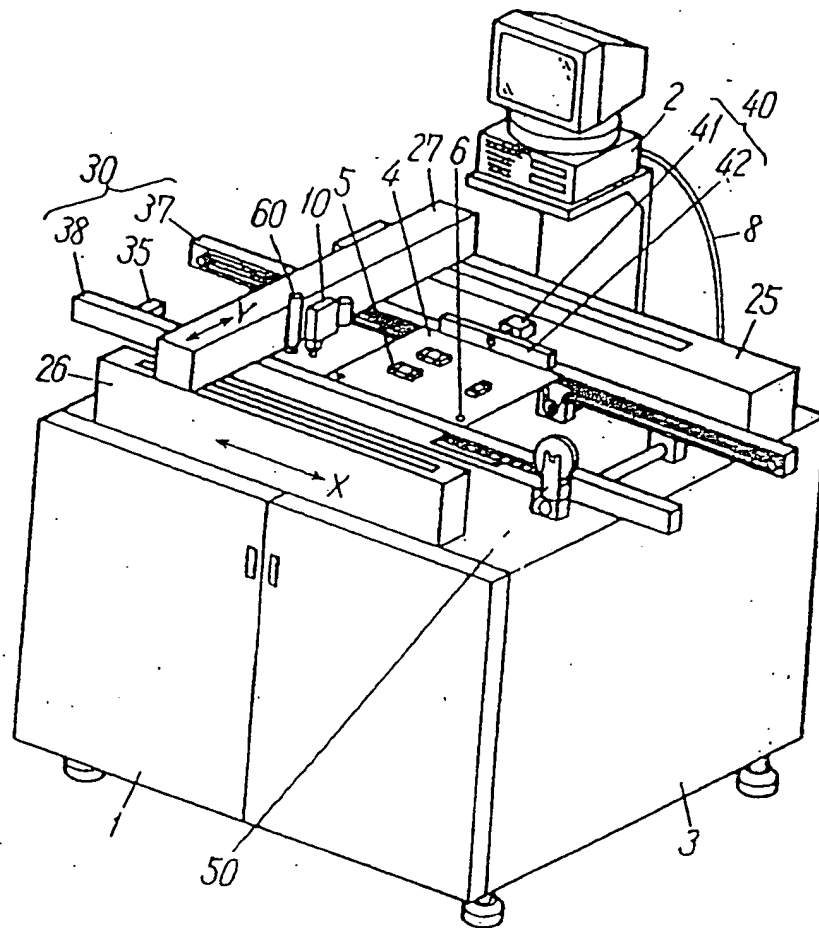
portion of the electronic component on the circuit board multiple times. Consequently, the existence and position of the electronic component on the circuit board can be detected accurately.

Hitherto depending on the scanning only by linear scanning, the trace could detect the end portion of the electronic component on the circuit board only twice. Therefore, the existence and position of the electronic component on the circuit board could not be detected accurately in the past.

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Fig. 1



FIELD OF THE INVENTION

The present invention relates to an exterior view inspecting apparatus for circuit board for detecting the existence and position of an electronic component on a circuit board.

BACKGROUND OF THE INVENTION

Fig. 38 shows a conventional exterior view inspecting apparatus for circuit board.

A displacement sensor 11 detects the existence and position of an electronic component on a circuit board. An X-axis robot 25 and a Y-axis robot 27 moves the displacement sensor 11. A pair of conveyors 30 disposed parallel convey a circuit board 4. A sensor 35 detects the arrival of the circuit board 4. A fixer 40 fixes the circuit board 4 so that it may not move during inspection. A controller 2 is connected through a signal cable 8, and controls this apparatus.

As shown in Fig. 39, the X-axis robot 25 and Y-axis robot 27 move the displacement sensor 11 according to the position data of an electronic component 5 stored in the controller 2.

The displacement sensor 11 scans the circuit board 4 along the route containing the electronic component 5, once in the X- or Y-direction with a laser beam.

By this scanning, the change in distance between the displacement sensor 11 and the circuit board 4 on which the electronic component 5 is mounted, which is called a displacement hereinafter, is detected.

Fig. 40 (a) shows a trace 300 of the laser beam emitted by the displacement sensor 11.

Fig. 40 (b) is a waveform of displacement detected by the displacement sensor 11, and level Ha denotes the circuit board 4, and level Hb shows the electronic component 5. By a threshold value 301 set between level Ha and level Hb, both ends L1 and L2 of the electronic component 5 are detected.

The exterior view inspecting apparatus for circuit board judges the existence of the electronic component 5 if both L1 and L2 are present, and judges the absence of the electronic component 5 if neither L1 nor L2 is present.

Furthermore, the exterior view inspecting apparatus for circuit board judges that the electronic component 5 is at a correct position if both L1 and L2 are in a predetermined area, and judges that the electronic component 5 is at a wrong position if L1 and/or L2 is outside the predetermined area.

The conventional exterior view inspecting apparatus for circuit board, however, does not detect the deviation of position of the electronic component 5 indicated by broken line 5a or 5b in Fig. 40 (a) because L1 and L2 in this case cannot be distinguished from the correct position of L1 and L2 of the electronic

This problem may be solved by increasing the number of scanings by the displacement sensor 11, but it requires starting and stopping of the X-axis robot and Y-axis robot on every scanning, and it gives rise to a new problem of necessity of a long time for inspection, which is not preferable.

The invention hence presents an exterior view inspecting apparatus for circuit board capable of detecting the position of an electronic component on a circuit board accurately and in a short time.

SUMMARY OF THE INVENTION

The exterior view inspecting apparatus for circuit board of the invention comprises:

a sensor unit for emitting laser beam to an object to be inspected, and detecting the displacement of the object by focusing the reflected light on an photoelectric transducer by using a receiving lens,

an optical path converter unit for refracting the optical path of radiation laser beam,

a sensor head unit incorporating the sensor unit and the optical path converter unit.

a control unit for moving the sensor head unit along a specified scanning route,

a correction unit for correcting the displacement data of the object to be inspected detected by the sensor unit, and

a judging unit for judging the existence and position of an electronic component on a circuit board from the corrected displacement data.

The optical path converter unit comprises a flat glass plate inclined to the optical path of the radiation laser beam, rotating around the axial center parallel to the optical path.

By this optical path converter unit, the optical path of the radiation laser beam is refracted so that the radiation laser beam scans the circuit board drawing a small circular trace.

drawing a small circular trace, the trace can detect the end portion of electronic components on the circuit board multiple times. Consequently, the existence and position of the electronic components on the circuit board can be detected more accurately.

Conventionally, the scanning was done by linear tracing, so the trace could detect the end position of the electronic component on the circuit board only twice.

Therefore, the existence and position of the electronic component on the circuit board could not be detected accurately hitherto.

In other mode of the exterior view inspecting apparatus for circuit board of the invention does not have the optical path converter unit.

The sensor unit of it moves drawing a small circular trace so that the trace of the radiation laser beam drawing a small circle.

BRIEF DESCRIPTION OF THE DRAWINGS

Fig. 1 is a perspective view showing the constitution of an exterior view inspecting apparatus for circuit board in a first embodiment of the invention.

Fig. 2 is a block diagram showing the circuit constitution of the personal computer used in the same apparatus.

Fig. 3 is a front view showing the principle of the displacement sensor used in the same apparatus.

Fig. 4 is a perspective view of a sensor head showing the refracted trace of laser beam in the same apparatus.

Fig. 5 is a perspective view showing the sticker feed part in the same apparatus.

Fig. 6 is a flow chart showing the method of inspection of presence or absence and deviation of position of an electronic component in the same apparatus.

Fig. 7 (a) is a conceptual diagram showing the principle of inspection of the same apparatus.

Fig. 7 (b) is a plan view showing the trace of the laser beam.

Fig. 8 is a waveform diagram showing the principle of inspection of the same apparatus.

Fig. 9 (a) is a perspective view showing the state of scanning over an electronic component by the laser beam in the same apparatus.

Fig. 9 (b) is a waveform diagram of the same.

Fig. 10 is a front view showing the state of scanning over an electronic component by the sensor head unit.

Fig. 11 (a) is a plan view showing the trace of the laser beam in Fig. 10.

Fig. 11 (b) is a waveform diagram of the height data of Fig. 10.

Fig. 12 is a flow chart for judging the presence or absence and deviation of position of an electronic component.

Fig. 13 is a plan view showing the state of scanning over an electronic component mounted in a wrong position by the sensor head unit of the apparatus.

Fig. 14 is a plan view showing the trace of laser beam in Fig. 13.

Fig. 15 is a waveform diagram of the height data in Fig. 13.

Fig. 16 is an essential perspective view showing a sensor head unit of an exterior view inspecting apparatus for circuit board in a second embodiment of the invention.

Fig. 17 is a front view showing the state of scanning over an electronic component by the sensor head unit in the same embodiment.

Fig. 18 is a plan view showing the trace of laser beam in Fig. 17.

Fig. 19 is a waveform diagram showing the height

Fig. 20 is a front view showing the state of scanning over an electronic component mounted in a wrong position by the sensor head unit in the same embodiment.

Fig. 21 is a plan view showing the trace of laser beam in Fig. 20.

Fig. 22 is a waveform diagram of height data of the electronic component in Fig. 20.

Fig. 23 is an essential perspective view showing a sensor head unit of an exterior view inspecting apparatus for circuit board in a third embodiment of the invention.

Fig. 24 is an essential perspective view showing the trace of refracted laser beam in the same embodiment.

Fig. 25 is a front view showing the state of scanning over an electronic component by the sensor head unit in the same embodiment.

Fig. 26 is a plan view showing the trace of the laser beam in Fig. 25.

Fig. 27 is a waveform diagram of height data of the electronic component in Fig. 25.

Fig. 28 is a front view showing the state of scanning over an electronic component mounted in a wrong position by the sensor head unit in the same embodiment.

Fig. 29 is a plan view showing the trace of the laser beam in Fig. 28.

Fig. 30 is a waveform diagram of height data of the electronic component in Fig. 28.

Fig. 31 is an essential perspective view showing a sensor head unit of an exterior view inspecting apparatus for circuit board in a fourth embodiment of the invention.

Fig. 32 is a flow chart showing the method of inspection of presence or absence and deviation of position of an electronic component in the same embodiment.

Fig. 33 is a perspective view showing the state of scanning over an electronic component by the sensor head unit in the same embodiment.

Fig. 34 (a) is a plan view showing a scanning example of a sensor head unit in a fifth embodiment of the invention.

Fig. 34 (b) is a plan view showing a scanning example in the case of varying the radius of rotation of the same laser beam.

Fig. 35 is a perspective view explaining the angle variable mechanism of a flat sheet glass in the same embodiment.

Fig. 36 (a) is an essential side view showing the detail of a sensor head unit in a sixth embodiment of the invention.

Fig. 36 (b) is its bottom view.

Fig. 37 is a side view showing the means for varying the radius of rotation in a seventh embodiment of the invention.

tution of a conventional exterior view inspecting apparatus for circuit board.

Fig. 39 is an essential perspective view showing the state of scanning over an electronic component by a displacement sensor in Fig. 38.

Fig. 40 (a) is a plan view showing the trace after scanning in Fig. 39.

Fig. 40 (b) is a waveform diagram of the same height data.

DETAILED DESCRIPTION OF THE INVENTION

(Example 1)

Fig. 1 is a perspective view showing an exterior view inspecting apparatus for circuit board of the invention, which comprises an inspection unit 1 for detecting the existence and position of an electronic component, and a personal computer 2 for controlling the inspection unit 1.

The inspection unit 1 comprises a sensor head unit 10 for detecting an electronic component 5 mounted on a circuit board 4 possessing an origin hole 6, an X-axis robot 25 for moving the sensor head unit 10, an auxiliary robot 26 disposed parallel to the X-axis robot 25, a Y-axis robot 27 disposed on the auxiliary robot 26 orthogonally to the X-axis robot 25, a conveyor unit 30 consisting of a first conveyor rail 37 and a second conveyor rail 38 for conveying the circuit board 4, an arrival sensor 35 for detecting the arrival of the conveyed circuit board 4 at the detection position, a fixer 40 consisting of a cylinder 41 and a block 42 for fixing the circuit board 4 so as not to be vibrated during inspection, a sticker feeder 50 for marking a defective position, and a suction head 60 for marking the defective position with a sticker.

Fig. 2 is a block diagram showing a circuit configuration of the personal computer 2. In a memory circuit 70, the shape of the electronic component 5, circuit board shape, mounting information position information (these are collectively called basic information) and the origin information of the circuit board 4 are stored.

A mounting position judge circuit 71 issues the shape and mounting direction of the electronic component 5. A scanning signal output circuit 72 controls the X-axis robot 25 and Y-axis robot 27 by the information from the mounting position judge circuit 71. A rotation signal output circuit 73 controls the rotation of a refractor of the sensor head unit 10 by the information from the mounting position judge circuit 71. In a correction circuit 74, the data from a displacement sensor 11 is corrected.

In a judge circuit 75, by the information from the correction circuit 74, the existence and position of an electronic component are judged. In an interface circuit 76, the conveyor unit 30, arrival sensor 35, fixer

connected through signal cables 8.

Fig. 3 shows the displacement sensor 11. The displacement sensor 11 measures the displacement by the trigonometric method. A laser beam 13 emitted from a light source 12a is refracted by a refractor 14 made of flat sheet glass. The refractor 14 is supported on a pipe 15. A servo motor 20 rotates the pipe 15 as required.

Numeral 12c denotes a receiver composed of multiple photoelectric transducers. The laser beam 13 emitted from the light source 12a is reflected by the circuit board 4 and electronic component 5, and passes through the lens 12b and enters the receiver 12c. Depending on the position of input of reflected light in the receiver 12c, the displacement is detected.

Fig. 4 is a perspective view showing the sensor head unit 10 and suction head unit 60 mounted on the Y-axis robot 27. The displacement sensor 11 is mounted on a bracket 21.

The pipe 15 is rotatably inserted in a bearing 16. The refractor 14 is mounted on the pipe 15 at an inclination to the axial direction.

When the motor 20 rotates, the pipe 15 and refractor 14 rotate through the belt 3. Consequently, the laser beam 13 changed in optical path by the refractor 14 rotates together with the refractor 14.

The suction head unit 60 comprises a cylinder 61, a suction nozzle 64, and a bracket 63 for fixing the suction nozzle 64 and cylinder 61. The cylinder 61 moves in the direction of arrow D by air pressure, and the suction nozzle 64 moves together with the cylinder 61.

Fig. 5 is a perspective view of the sticker feeder 50. The stickers 52 are adhered to a base paper 53 at specific intervals, and guided from a reel 54 to a feed stage 56. The stickers 52 are attracted to the suction nozzle 64 on the feed stage 56. The base paper 53 is taken up on a reel 58 by rotation of a motor 57.

As shown in Fig. 1, the circuit board 4 is conveyed up to the inspection stage by the conveyor unit 30, and when the arrival sensor 35 detects the arrival of the circuit board 4, the conveyor unit 30 stops. In consequence, the fixer 40 presses the circuit board 4 against the conveyor rail 38 to fix so as not to move during inspection.

Next, the position of the origin of the X-direction and Y-direction is determined. On the basis of the information possessed by the memory circuit 70 in the personal computer 2, the X-axis robot 25 and the Y-axis robot 27 move the displacement sensor 11. The displacement sensor 11 scans the circuit board 4, detects the edge of the origin hole 6, and determines its central position by calculation. The obtained central position is the position of the origin.

In the memory circuit 70 of the personal computer 2, the shape of the electronic component 5 and the

formation, the electronic component 5 mounted on the circuit board 4 is scanned once by the displacement sensor 11. By judging the signal generated by the displacement sensor 11 by the judge circuit 75 in the personal computer 2, the existence and position of the electronic component 5 can be detected.

Furthermore, when scanning the electronic component 5, by simultaneously scanning the circuit board in its vicinity, the height of the electronic component 5 from the circuit board is detected. If defect is judged as a result of detection, the suction head unit 60 moves onto the sticker feed stage 56, and the suction nozzle 64 is lowered to suck the sticker 52. The suction head unit 60 then moves onto the defective position. The suction nozzle 64 sucking the sticker 52 descends on the electronic component 5 and cancels the suction, so that the sticker 52 is adhered to the electronic component 5. This action is repeated whenever a defect occurs.

When marking is over, the fixing block 42 cancels the fixing of the circuit board. The circuit board 4 is conveyed to the next process by the conveyor unit 30. Fig. 6 is a flow chart showing this flow.

As shown in Fig. 7, the laser beam 13 emitted from the light source 12a is reflected by B1 of the measuring surface 91 if the refractor 14 is not provided, and is focused on B1a on the receiver 12c through the lens 12b. When the measuring surface is 92, reflected by B10, the laser beam is focused on B2a on the receiver 12c, and by the difference of B1a and B2a, the displacement of the measuring surface 91 and measuring surface 92 is measured. When the measuring surface is 91, if the refractor 14 is at the position of solid line, the laser beam 13 is emitted to B2 according to the Snell's law. When the refractor 14 is at the position of the broken line, the laser beam 13 is emitted to B3. Therefore, by rotating the refractor 14, the trace of the laser beam 13 on the measuring surface 91 becomes as shown in Fig. 7 (b).

In this way, when the refractor 14 is as indicated by solid line in Fig. 7 (a), the laser beam 13 is emitted to B2. This is equivalent to emission to B10 as seen from the receiver 12c. When the refractor 14 is as indicated by broken line in Fig. 7 (a), the laser beam 13 is emitted to B3. This is equivalent to emission to B11 as seen from the receiver 12c.

That is, when the refractor 14 is present, if the measuring surface is specific, the output of the displacement sensor 11 varies depending on the rotational angle θ of the refractor 14. When the refractor 14 is rotated a revolution, the output waveform of the displacement sensor 11 is 200 in Fig. 8. It is necessary to correct in order that the output of the displacement sensor 11 may not be influenced by the rotational angle θ of the refractor 14.

From the dimensions of the parts in Fig. 7 (a), the following expressions are established.

$$(2) \quad H2/S2 = (Z1 - H2)/X1$$

Herein, supposing the rightward direction in Fig. 7 (a) to be the + direction of the X-coordinate, the downward direction to be the + direction of the Z-coordinate, the displacement of the laser beam 13 to be S, and the change of measuring surface to be Hs, the above formulas (1) and (2) can be expressed in (3).

$$(3) \quad Hs = (Z1 \times S)/(X1 - S)$$

Moreover,

$$(4) \quad S = r \cos \theta$$

The distance up to the measuring surface 91 measured by the displacement sensor 11 in the presence of the refractor 14 is H, and the true distance in the absence of the refractor 14, that is, from the displacement sensor 11 to the measuring surface 91 is Z1, and hence

$$(5) \quad H = Hs + Z1$$

Therefore, the true distance Z1 desired to be determined is expressed as follows from the formulas (3), (4), (5).

$$Z1 = H(X1 - r \cos \theta)/X1$$

This formula shows that the true distance Z1 can be determined by correcting the distance H up to the measuring surface 91 measured by the displacement sensor 11 by using the rotational angle θ of the refractor 14, the radius of rotation r, and distance X1. When corrected by using this formula, the output waveform of the displacement sensor 11 in Fig. 8 is 201, which is flat regardless of θ .

Fig. 9 (a) shows the trace of one revolution of the laser beam 13 over the electronic component 5, and the waveform of displacement measured by the displacement sensor 11 at this time is 202 in Fig. 9 (b). Correction of this waveform yields 203. As a result, the position and thickness t of the electronic component can be measured.

Fig. 10 shows the inspection of circuit board by employing such method and correction. Fig. 11 shows the trace of scanning and waveform of displacement.

As shown in Fig. 10, the displacement sensor 11 scans once over the electronic component 5 on the circuit board. The laser beam 13 is turning by the rotation of the motor 20, and hence the tracing of the laser beam 13 is spiral 100.

Fig. 11 (b) shows the waveform (corrected) 102 of displacement. By setting a threshold 101 between the displacement level Hb of the circuit board 4 and the displacement level Ha of the electronic component 5, the displacement changing points L1 to 2, W1 to 4 can be detected.

The position and height of the electronic component 5 on the circuit board 4 can be detected according to the flow chart in Fig. 12 from the positions of the displacement changing points L1 to 2, W1 to 4.

Fig. 13 and Fig. 14 show the case of scanning over the electronic component 5 deviated in position

by the displacement sensor 11 while rotating the refractor 14.

In the diagrams, the solid line refers to the electronic component 5 mounted at a wrong position, and the broken line indicates the correct position of the electronic component 5.

The output waveform of the displacement sensor 11 is indicated by solid line in Fig. 15, but if the position of the electronic component 5 is not deviated, it should be indicated by broken line. The waveform of broken line is obtained from the basic information stored in the memory circuit 70 in the personal computer 2, which includes the correct position information of the electronic component 5. By comparing the waveform of broken line and the waveform of solid line in Fig. 15, the deviation of position of the electronic component 5 can be detected.

(Example 2)

The constitution of the exterior view inspecting apparatus for circuit board of the embodiment is same as in Example 1, and is not hence described herein.

Fig. 16 shows the sensor head unit, in which the servo motor 80 rotates normally and reversely, intermittently, to drive the refractor 14.

In Fig. 17 and Fig. 18, the displacement sensor 11 scans once over the electronic component 5 in the direction of arrow G. By intermittent normal and reverse rotation of the servo motor, the trace of the laser beam is trapezoidal.

The basic information including the position and shape of the electronic component 5 is stored in the memory circuit 70 of the personal computer 2. The scanning route of the displacement sensor 11 is determined by the position information of the electronic component 5. The width of the trapezoid of the trace of the laser beam is set smaller than the width of the electronic component 5 by the shape information of the electronic component 5.

In Fig. 18, the refractor 14 stops before M1, rotates normally from M1 to M2, stops from M2 to M3, rotates reversely from M3 to M4, stops from M4 to M5, rotates normally from M5 to M6, and stops after M6.

Fig. 19 shows the waveform (corrected) of the height data delivered from the displacement sensor 11, and the height is the same from M1 to M6.

As the judge circuit 75 in the personal computer 2 judges that there is no changing point of the height level and height data, it is judged that the electronic component 5 has been mounted correctly.

If there is any changing point of the height data, by comparing with the basic information stored in the memory circuit 70 in the personal computer 2, it is inspected whether the electronic component 5 has been mounted correctly or not.

Fig. 20 and Fig. 21 show the case of the displace-

ment 5 deviated in position in the direction of arrow L, in the trapezoidal trace in the direction of arrow G. In the diagram, the solid line indicates the electronic component 5 mounted in a wrong position, and the broken line shows the correct position of the electronic component 5.

The output waveform of the displacement sensor 11 is indicated by solid line in Fig. 22, and if there is no deviation of position in the electronic component 5, it should be indicated by broken line. The waveform of broken line can be obtained from the basic information stored in the memory circuit 70 in the personal computer, this information containing the correct position information of the electronic component 5. By comparing the waveform of broken line and the waveform of solid line in Fig. 22, the deviation of position of the electronic component can be detected.

In the embodiment, the trace of the laser beam is trapezoidal, but it may be also sinusoidal wave, triangular wave, or sawtooth wave.

(Example 3)

The constitution of the exterior view inspecting apparatus for circuit board of this embodiment is same as in Example 1, and is not described herein.

Fig. 23 shows a sensor head unit. Parallel to the laser beam emitted from the displacement sensor 11, the pipe 15 coupled with the pulley 17 is rotatably installed. The motor 20 rotates the pipe 15 through a belt 18. On the pipe 15, a refractor 81 having a width W is mounted at an inclination in the axial direction.

As shown in Fig. 24, the laser beam emitted from the displacement sensor 11 is intermittently interrupted by the rotation of the refractor 81, and the optical path is changed. That is, when the refractor 81 is positioned in the optical path of the laser beam, the laser beam is refracted.

As shown in Fig. 25, the displacement sensor 11 scans over the electronic component 5 mounted on the circuit board 5 once in the direction of arrow G. As mentioned above, the laser beam is refracted by the refractor 81 when the refractor 81 is on the optical path, and passing over the electronic component 5, while rotating in the same direction as the refractor 81. Fig. 26 shows the trace of the laser beam.

Of the output of the displacement sensor 11, the laser beam is corrected in the correction circuit 74 in the personal computer 2 by the portion refracted by the refractor 81.

Fig. 27 shows the waveform of the height data (corrected) issued from the displacement sensor 11.

By comparing the changing point of the height level and height data with the basic information stored in the memory circuit 70 in the personal computer 2, the judge circuit 75 in the personal computer 2 detects the existence and position of the electronic

ment 5 has been mounted correctly or not.

(Example 4)

The constitution of the exterior view inspecting apparatus for circuit board in the embodiment is same as in Example 1, and is not described herein.

Fig. 31 shows the sensor head unit. The displacement sensor 11 is fixed through a bar 83 rotatably held on a pulley 85 by a bearing (not shown). One end of a lever 86 is fixed to the bar 83, while the other end of the lever 86 is rotatably coupled with one end of a lever 87. The displacement sensor 11 always indicates nearly the same direction as the lever 86. The other end of the lever 87 is rotatably coupled with a bracket 82.

By the rotation of the motor 20, the pulley 85 is rotated, and the bar 83 rotates together with the pulley 85. The displacement sensor 11 moves together with the bar 83, while indicating nearly the same direction as the lever 86.

In Fig. 33, the displacement sensor 11 scans over the electronic component 5 once in the direction of G while rotating in the direction of arrow E. The measured data obtained from the displacement sensor 11 is fed into the personal computer 2. However, since the optical path of the laser beam is not changed by the refractor, it is not necessary to correct the measured data as shown in the flow chart in Fig. 32. The waveform of the trace and height data of laser beam is same as in Fig. 11 relating to Example 1.

In this embodiment, meanwhile, since it is not necessary to correct the height data, the calculation time is short and it is efficient. To heighten the precision of inspection in the embodiment, meanwhile, needless to say, it is better to increase the rotating speed of the laser beam.

(Example 5)

The constitution of the exterior view inspecting apparatus for circuit board in the embodiment is same as in Example 1, and is not described herein.

The electronic component 5 in the dimensions indicated by solid line in Fig. 34 (a) can be measured by laser beam having the trace in the diameter of r . However, the electronic component 5 of smaller size in the dimensions indicated by broken line cannot be measured by the laser light having the trace in the diameter of r . The diameter of the trace of the laser beam can be changed by the inclination angle of the refractor. In this embodiment, by attaching the axis 14a for rotation to the refractor 14, the inclination angle of the refractor can be changed. The diameter of the trace of the laser beam is r_1 as shown in Fig. 34 (b), so that the electronic component 5 of smaller size in the dimension indicated by broken line can be measured.

a known mechanism, and the description is omitted.

(Example 6)

The constitution of the exterior view inspecting apparatus for circuit board in the embodiment is same as in Example 1, and is not described herein.

In Fig. 36 (a), (b), the motor 20 rotates the refractors 14a and 14b provided in pipes 15a and 15b through a drum 18a. The inclination angle differs between the refractors 14a and 14b, and the refractor 14a refracts the laser beam 13. In Fig. 36 (b), when the pipe 15a comes to the position indicated by broken line by a mechanism not shown herein, and the pipe 15b at the position once occupied by the pipe 15a, the diameter of the trace of the laser beam can be varied.

(Example 7)

Instead of the refractor 14, by varying the interval of the pair of trapezoidal glass sheets 14c and 14d shown in Fig. 37, the diameter of the trace of the laser beam can be varied, same as in Example 6.

Claims

1. An exterior view inspecting apparatus for circuit board comprising:

a sensor unit for emitting laser beam to an object to be inspected, and detecting the displacement of the object by focusing the reflected light on an photoelectric transducer by using a receiving lens,

an optical path converter unit for refracting the optical path of radiation laser beam,

a sensor head unit incorporating the sensor unit and the optical path converter unit.

a control unit for moving the sensor head unit along a specified scanning route,

a correction unit for correcting the displacement data of the object to be inspected detected by the sensor unit, and

a judging unit for judging the existence and position of an electronic component on a circuit board from the corrected displacement data.

2. An exterior view inspecting apparatus for circuit board of claim 1,

wherein the optical path converter unit comprises a flat sheet glass inclined to the optical path of the radiation laser beam, and this flat sheet glass rotates at least in one rotation mode out of three modes, continuous rotation, intermittent rotation, and intermittent inversion, around the axial center parallel to the optical path.

3. An exterior view inspecting apparatus for circuit board of claim 1,
 wherein the correction unit corrects the detection error of the displacement data of the object of inspection, which is generated by the existence of the optical path converter unit, by using
 the rotational angle of the optical path converter unit, the refracted distance of the optical path of the radiation laser beam in the optical path converter unit, and the distance between the optical path and receiving lens.
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4. An exterior view inspecting apparatus for circuit board of claim 1,
 wherein the optical path converter unit comprises a flat sheet glass inclined to the optical path of the radiation laser beam, and
 this flat sheet glass moves in and out of the optical path, and refracts the optical path when getting into the optical path.
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5. An exterior view inspecting apparatus for circuit board of claim 1,
 wherein the optical path converter unit comprises a flat sheet glass inclined to the optical path of the radiation laser beam, and
 means for adjusting the inclination of the flat sheet glass to the optical path.
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6. An exterior view inspecting apparatus for circuit board of claim 1, further comprising:
 a plurality of optical path converter units, and
 means for disposing selectively one of the plurality of optical path converter units on the optical path of radiation laser beam.
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7. An exterior view inspecting apparatus for circuit board of claim 1,
 wherein the optical path converter unit is comprising
 a pair of lenses having confronting slopes on the optical path of radiation laser beam.
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8. An exterior view inspecting apparatus for circuit board of claim 1, further comprising:
 a sensor unit for emitting laser beam to the object of inspection, and focusing the reflected light on the photoelectric transducer by using the receiver lens to detect the displacement of the object of inspection,
 50
 a controller for moving the sensor unit along a specified scanning route, while drawing a specified form of the trace of the optical path of the radiation laser beam, and
 55

position of an electronic component on the circuit board from the displacement data detected by the sensor unit.

Fig. 1

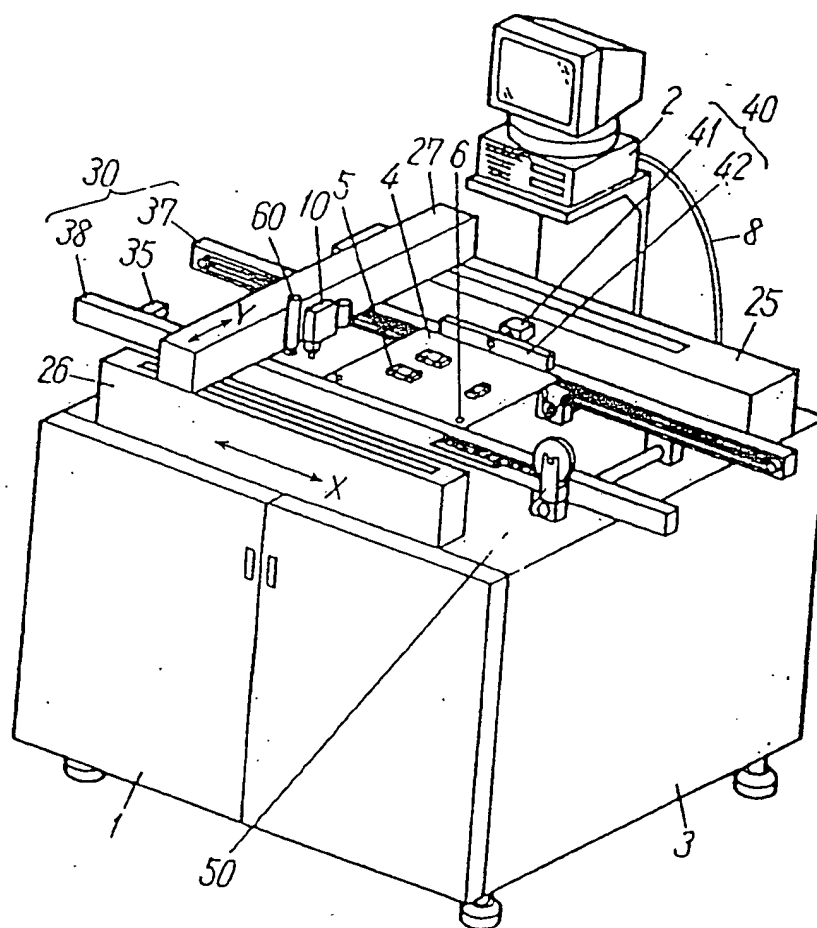


Fig. 2

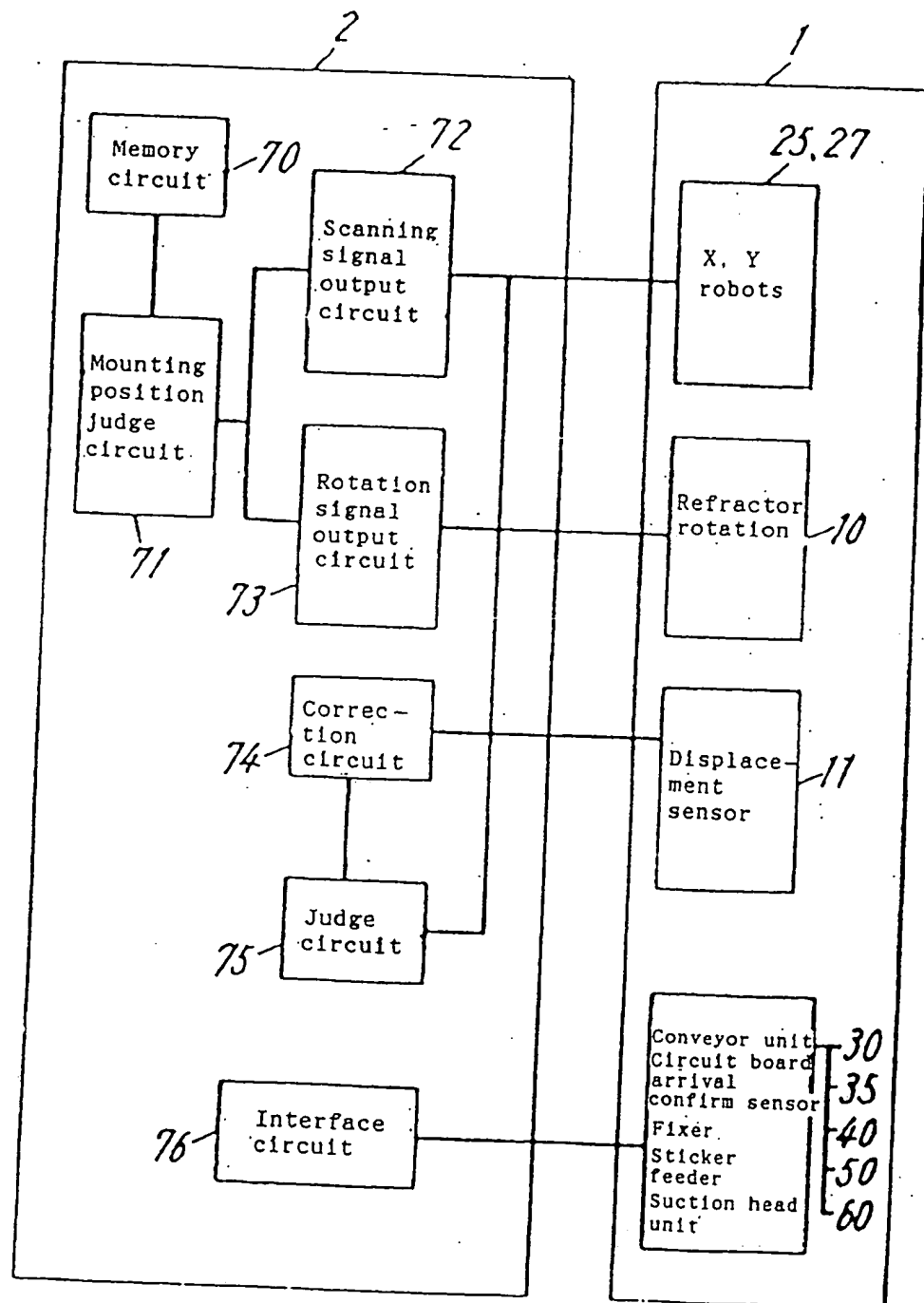


Fig. 3

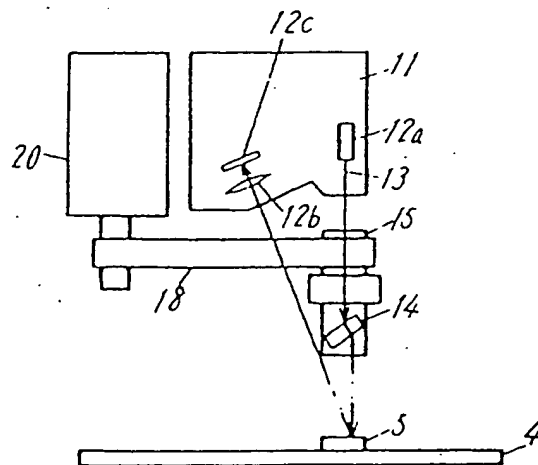


Fig. 4

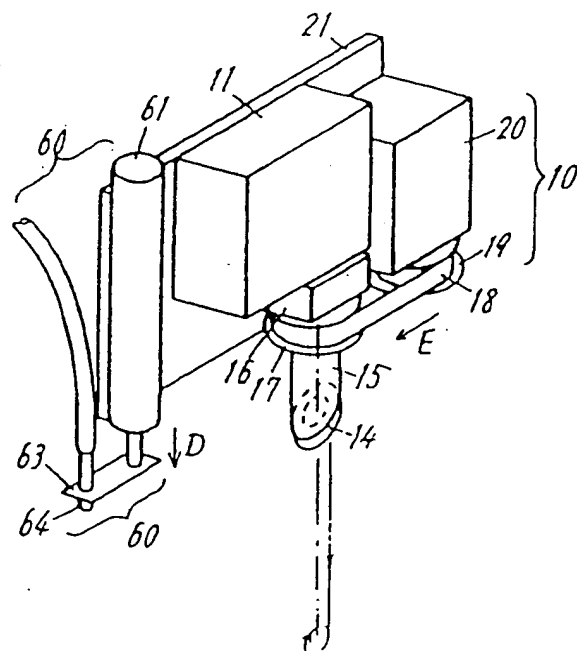


Fig. 5

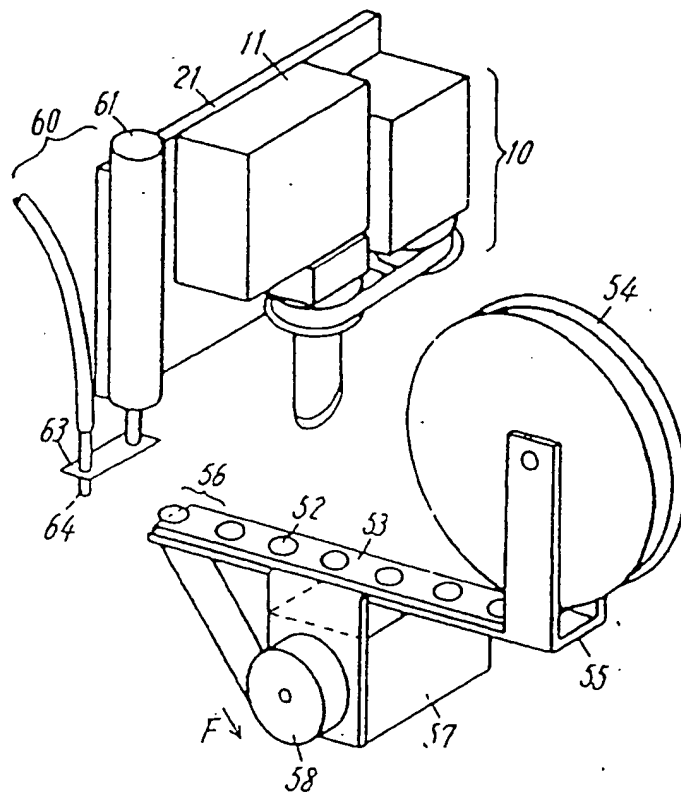


Fig. 6

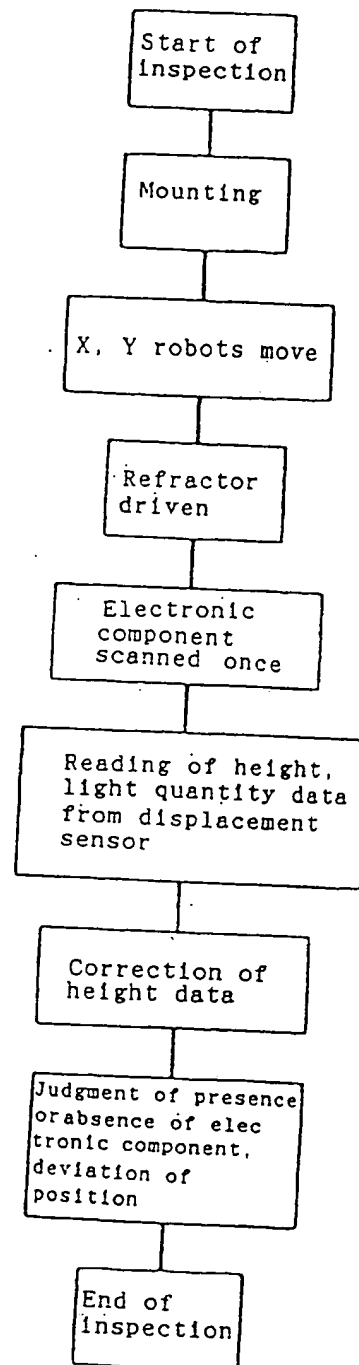
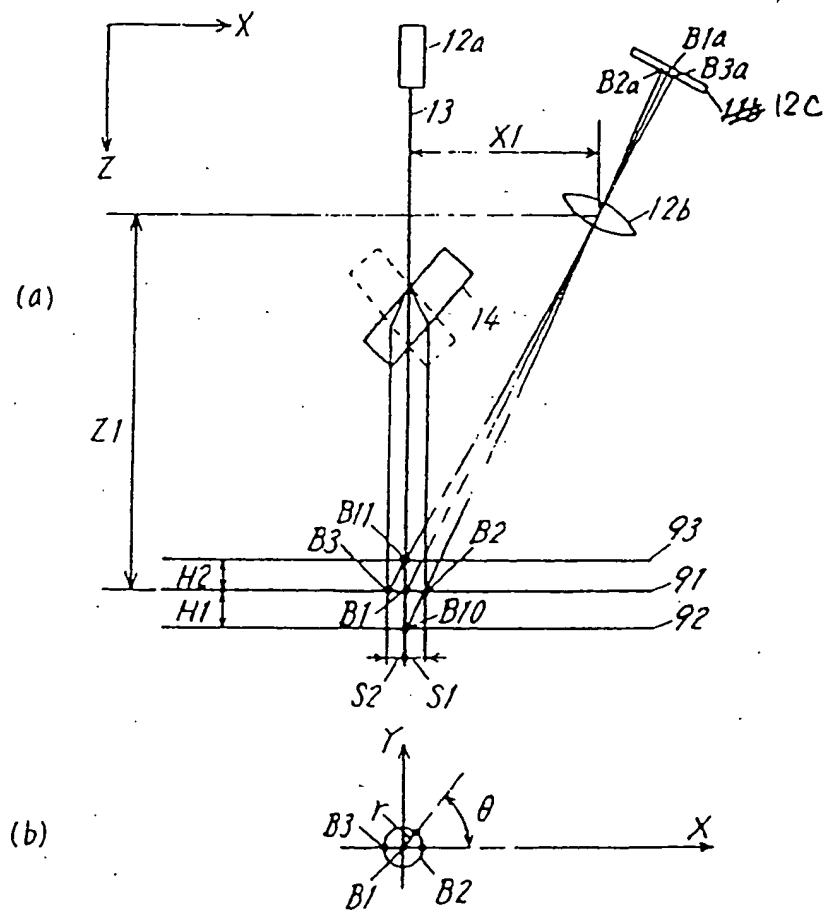


Fig. 7





European Patent
Office

EUROPEAN SEARCH REPORT

Application Number
EP 94 10 0133

DOCUMENTS CONSIDERED TO BE RELEVANT

Category	Citation of document with indication, where appropriate, of relevant passages	Relevant to claim	CLASSIFICATION OF THE APPLICATION (Int.CI.5)
X	FUJITSU-SCIENTIFIC AND TECHNICAL JOURNAL, vol.26, no.1, April 1990, KAWASAKI JP pages 16 - 25, XP138215 KOEZUDA 'High-Speed, Wide Area 3-D Vision System for PWB Inspection' * the whole document *	1,8	H05K13/08
Y	---	3,6,7	
Y	WO-A-91 11290 (OXFORD SENSOR TECHNOLOGY) * figure 1 *	3,7	
Y	EP-A-0 365 182 (EOTRON) -----	6	
The present search report has been drawn up for all claims			TECHNICAL FIELDS SEARCHED (Int.CI.5)
			H05K G02B

Place of search

THE HAGUE

Date of completion of the search

11 March 1994

Examiner

Bertin, M

CATEGORY OF CITED DOCUMENTS

X : particularly relevant if taken alone
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A : technological background
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T : theory or principle underlying the invention
E : earlier patent document, but published on, or after the filing date
D : document cited in the application
L : document cited for other reasons

& : member of the same patent family, corresponding document

Fig. 37

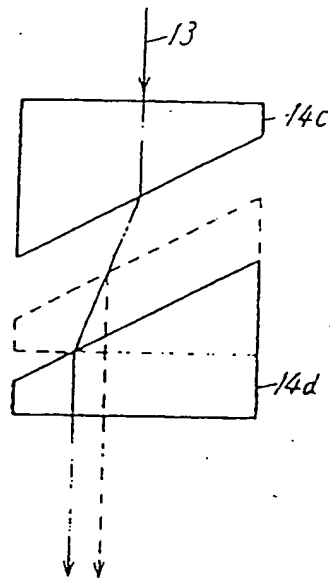


Fig. 38

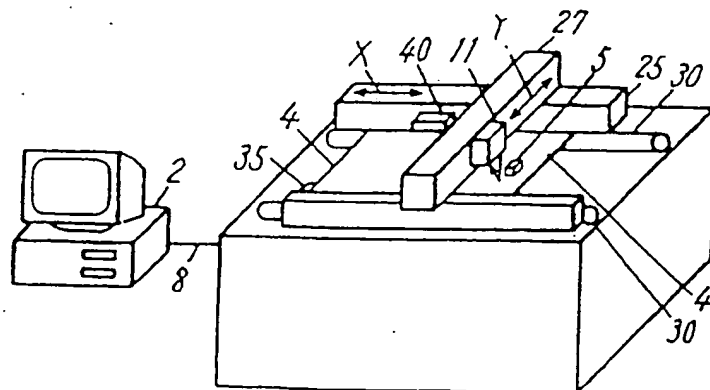


Fig. 39

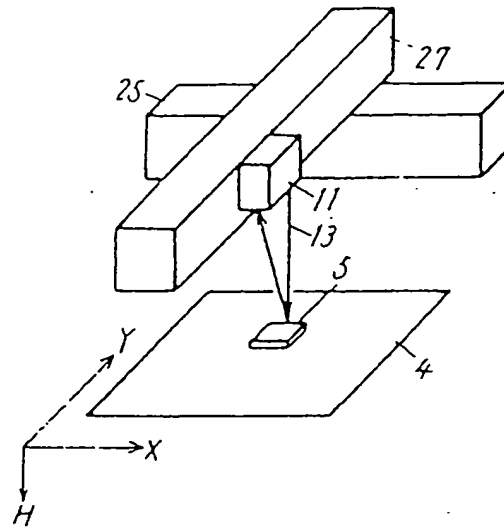


Fig. 40

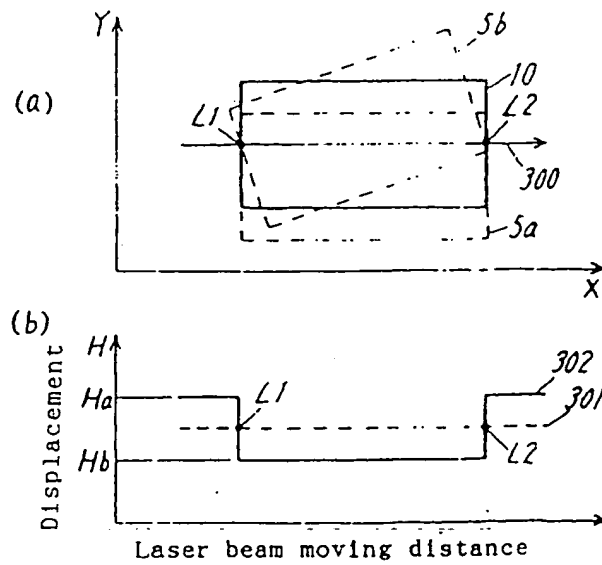


Fig. 8

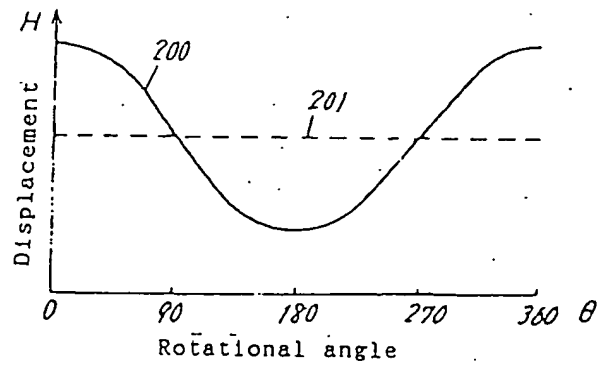


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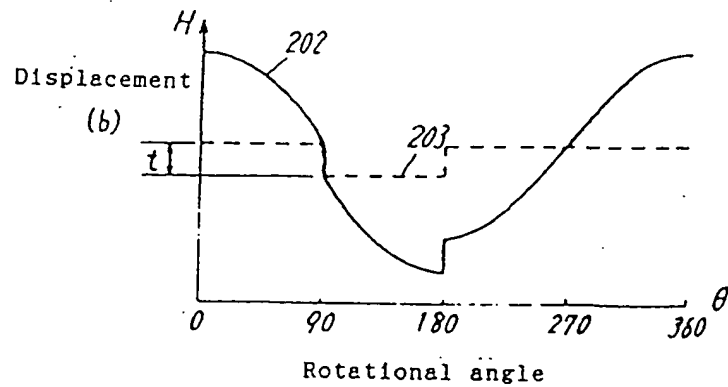
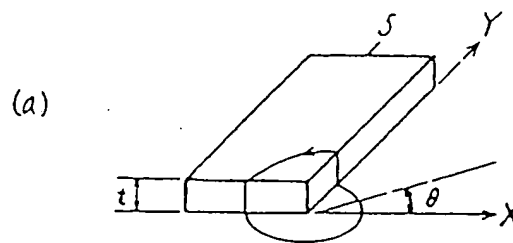


Fig. 10

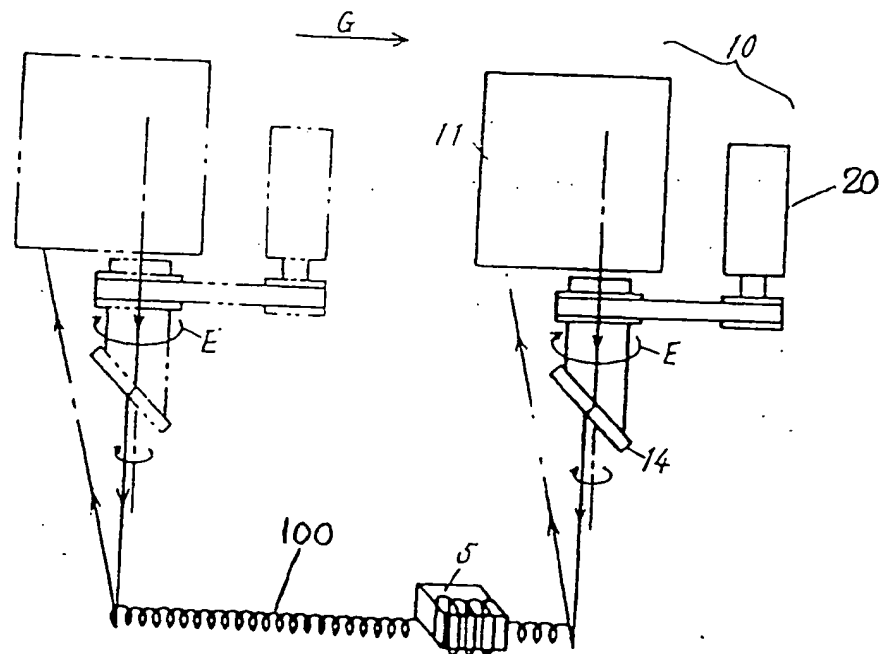


Fig. 11

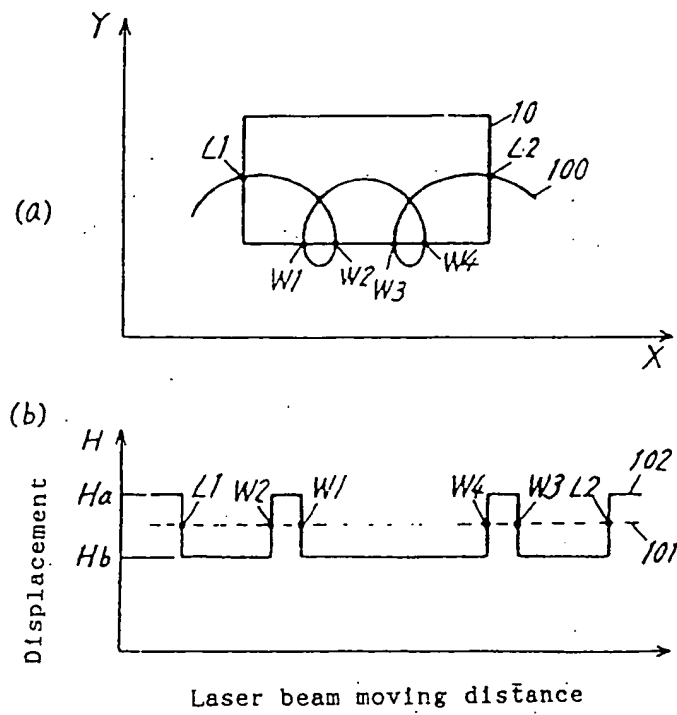


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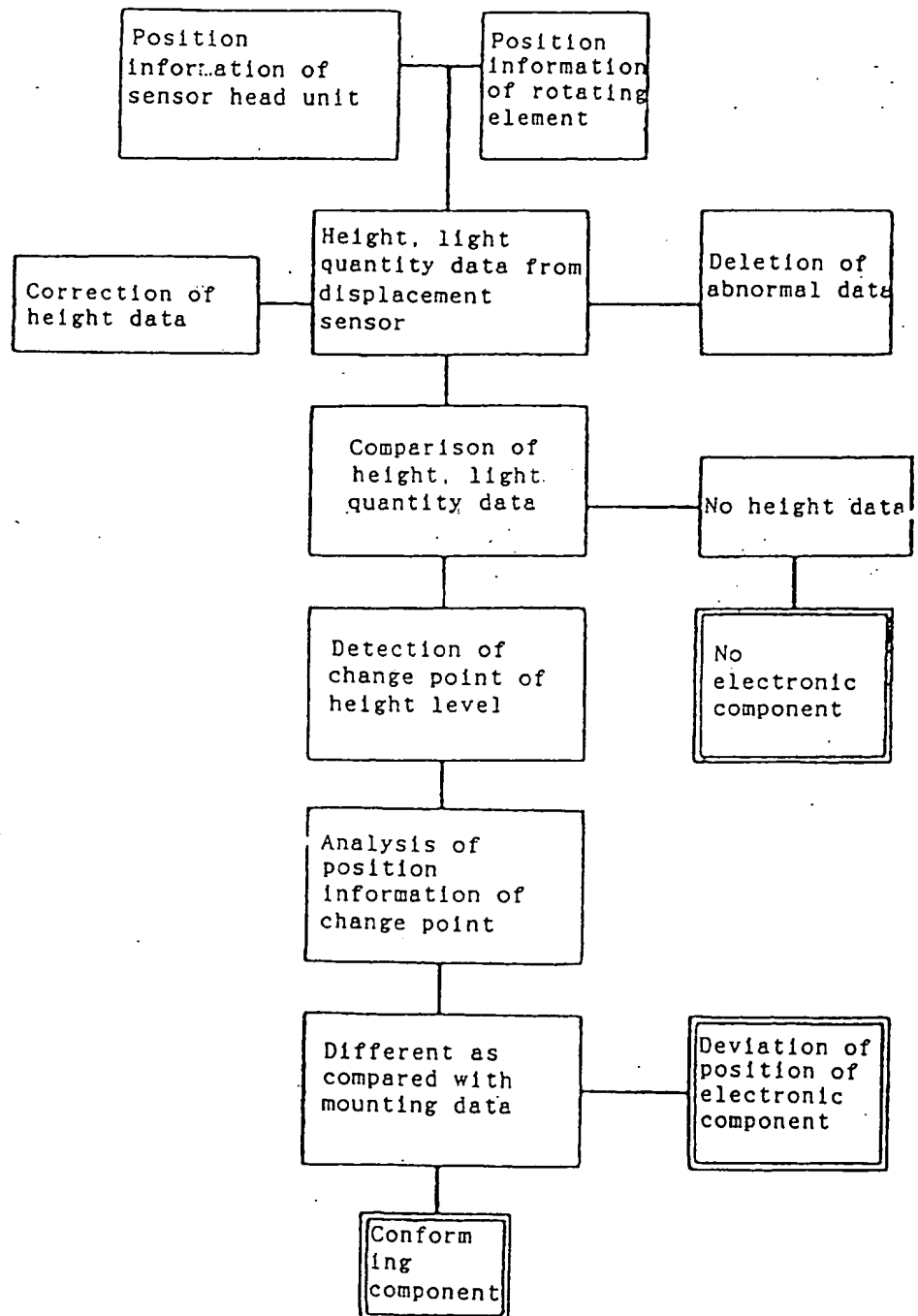


Fig. 13

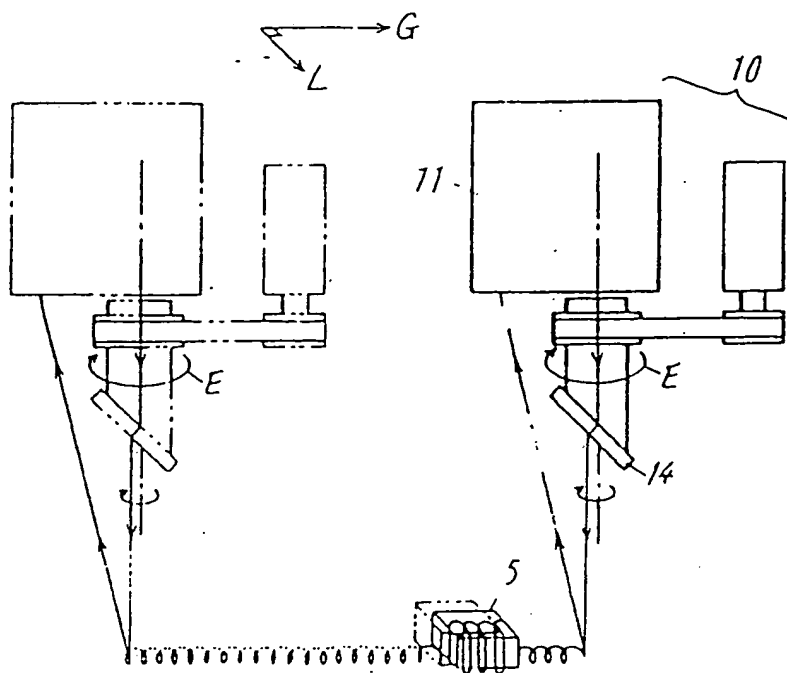


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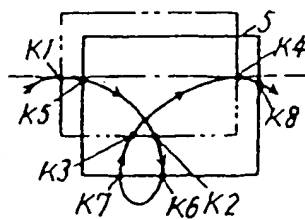


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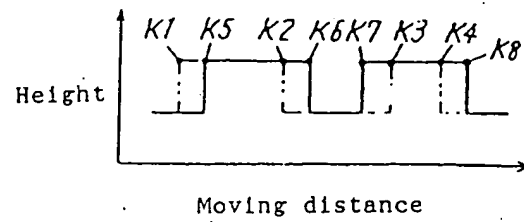


Fig. 16

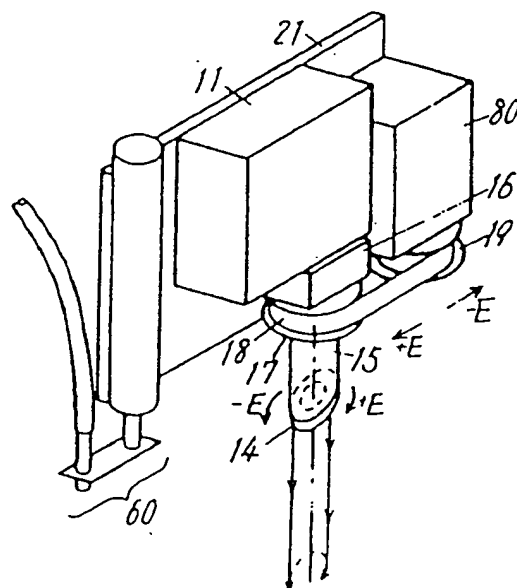


Fig. 17

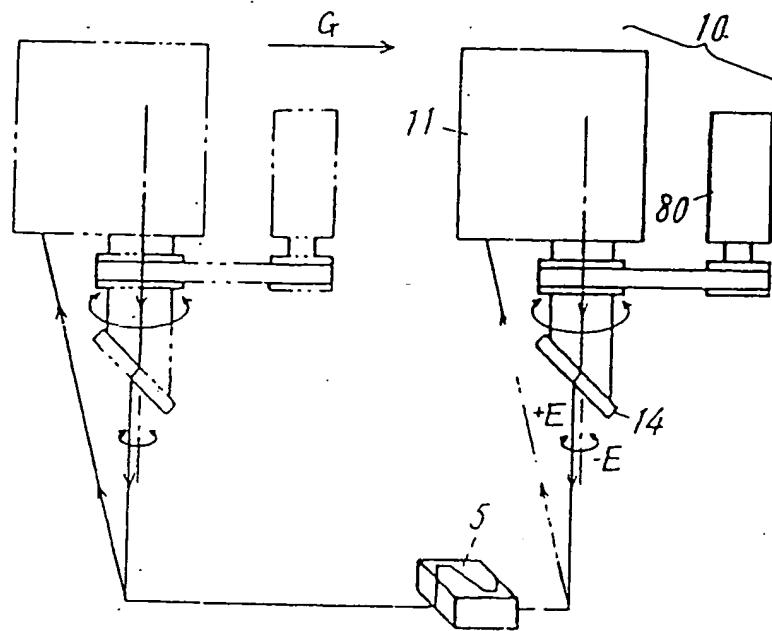


Fig. 18

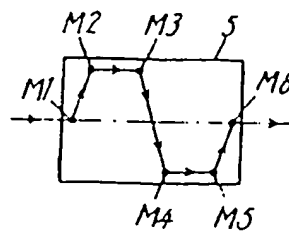


Fig. 19

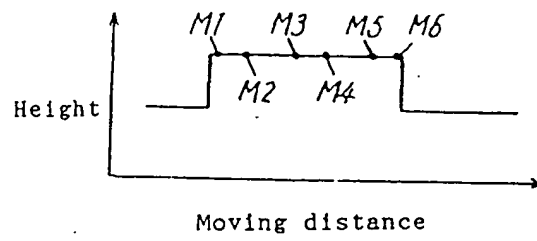


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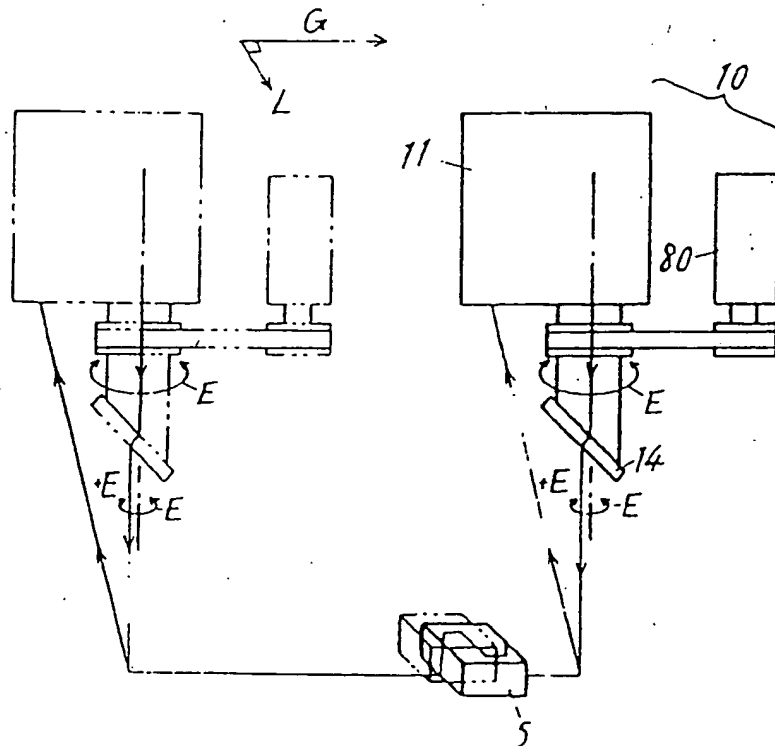


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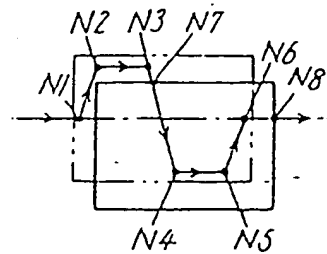


Fig. 22

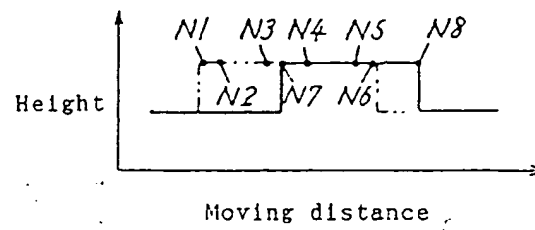


Fig. 23

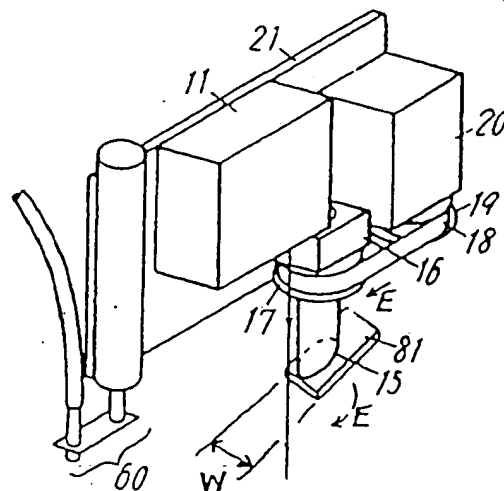


Fig. 24

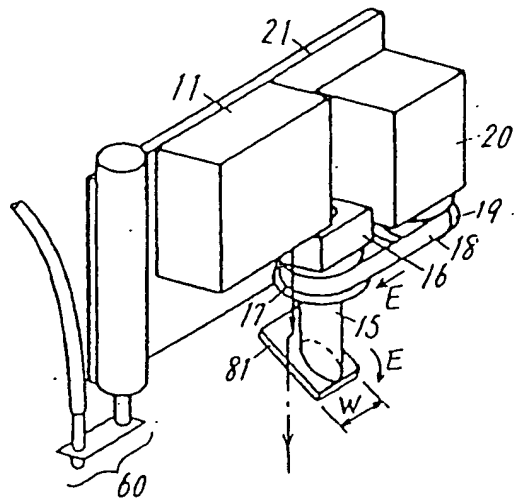


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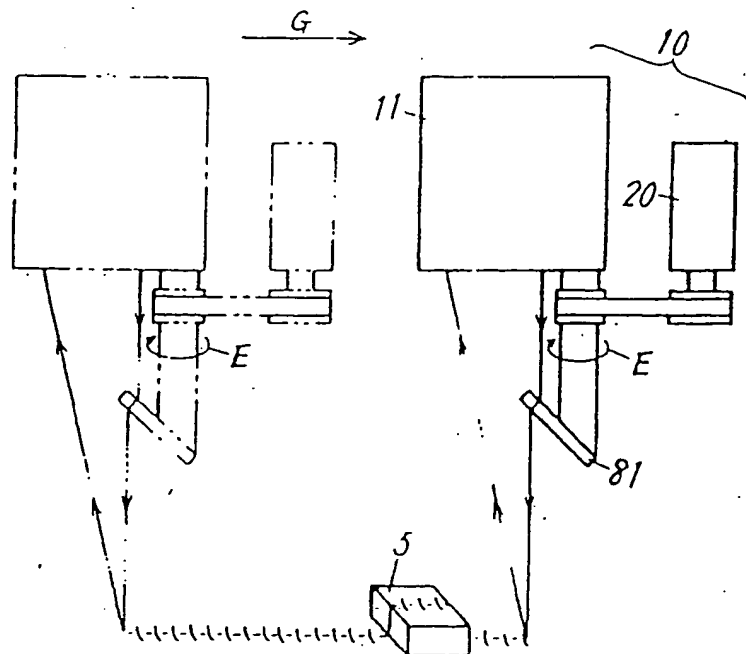


Fig. 26

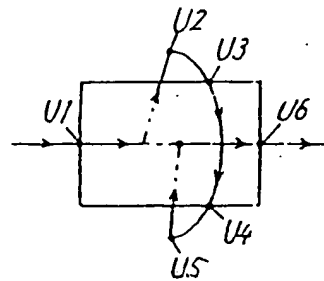


Fig. 27

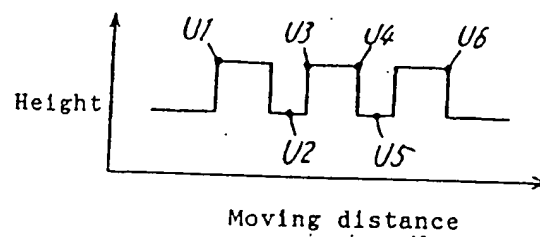


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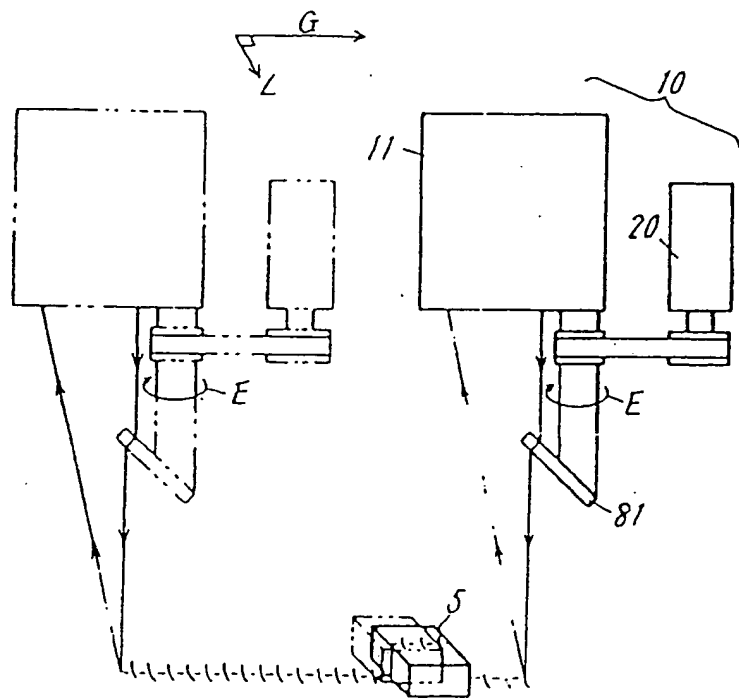


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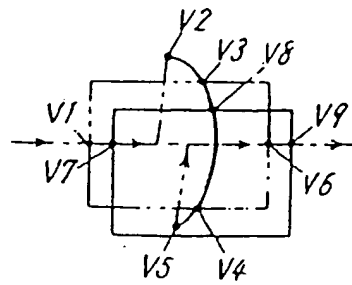


Fig. 30

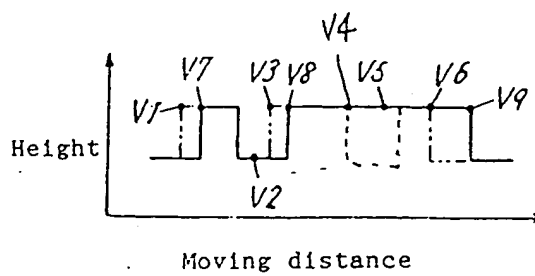


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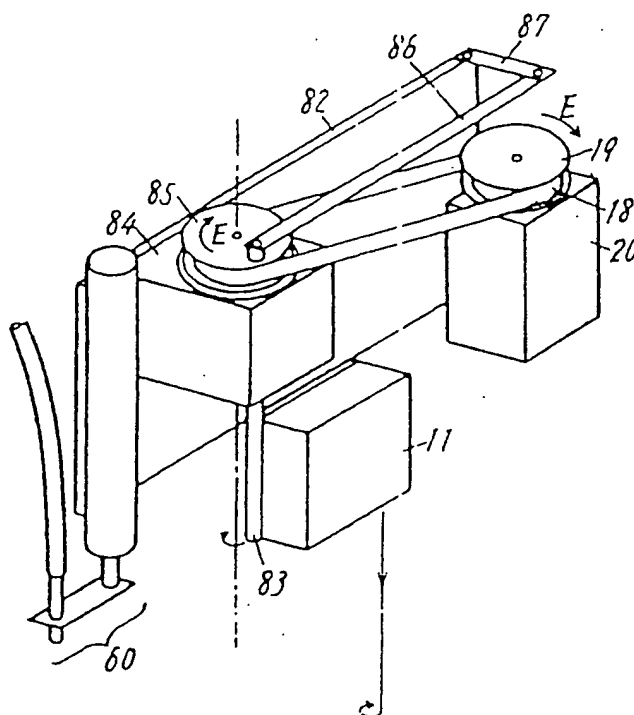


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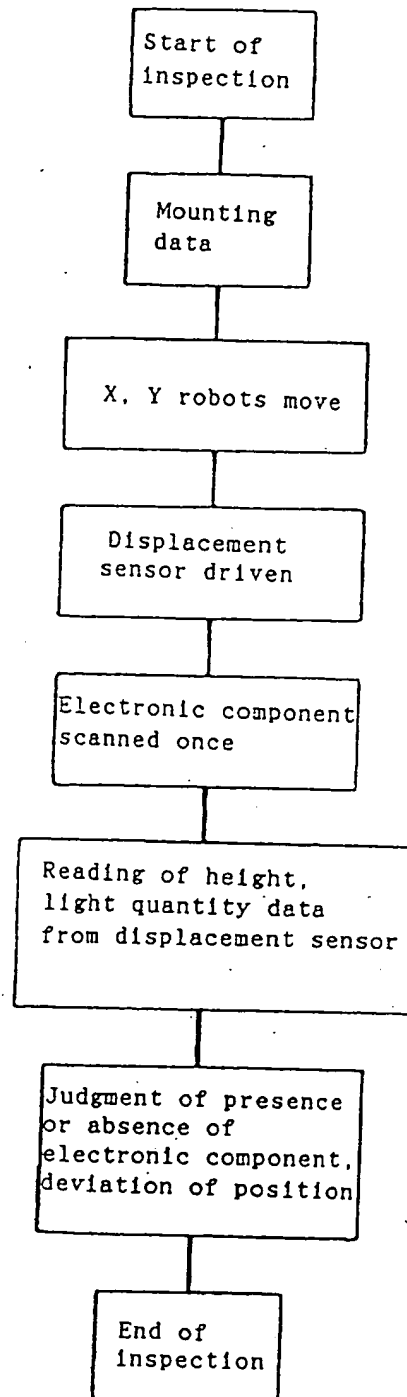


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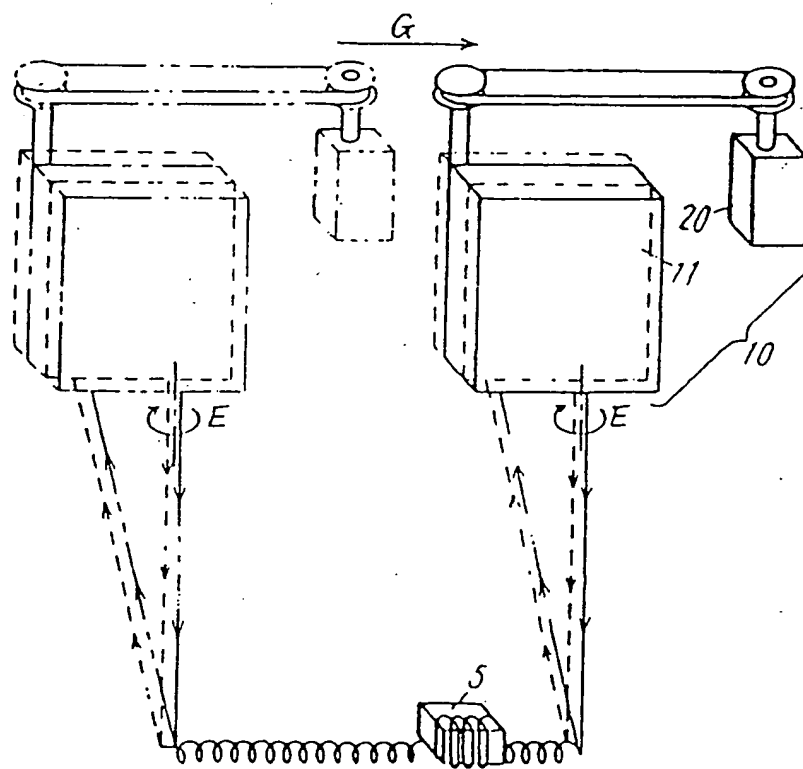


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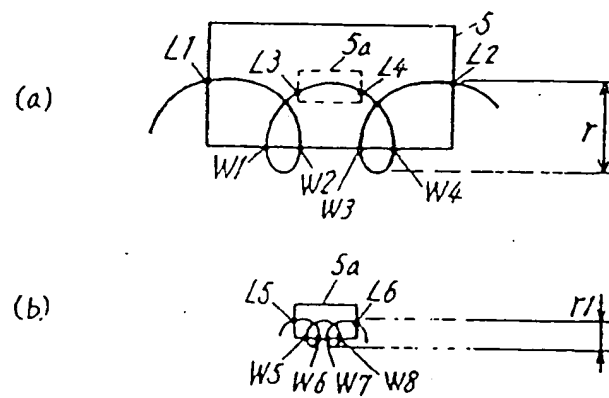


Fig. 35

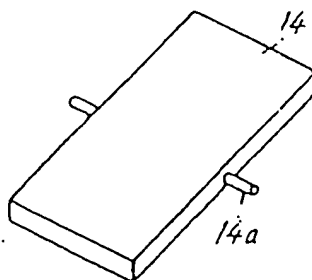
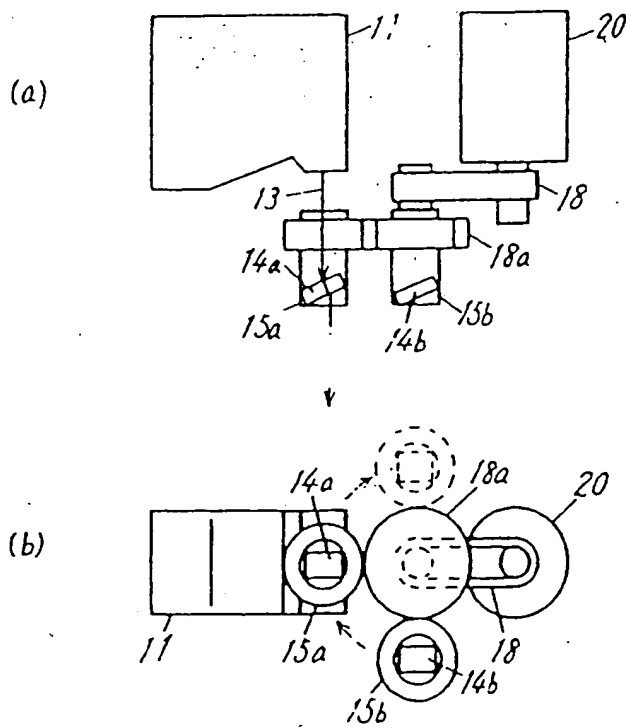


Fig. 36



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